MDTE Series

Wire Wound Molded SMD Power Inductors Size 1580



FEATURES

- Soft saturation
- High current, low DCR, high efficiency
- Very low acoustic noise and very low leakage flux noise
- High reliability
- 100% Lead(Pb)-Free and RoHS compliant
- Operating temperature -55~+125 °C (Including self temperature rise)
- Quantity: 200pcs

APPLICATION

- Note PC power system, incl. IMVP-6
- DC/DC converter

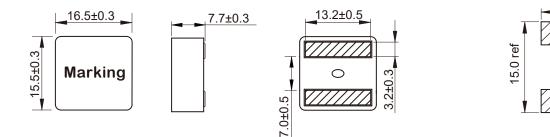
Dimensions: [mm]

Land Pattern: [mm]

15.0 ref

6.0 ref

KOHERelec



Electrical Properties:

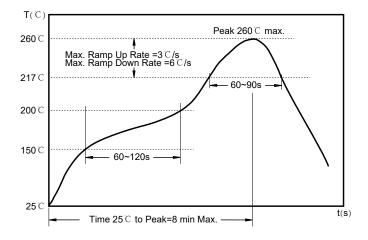
Part No	Inductance @ 100KHz/0.1V (μH)	Tolerance	Saturation Current Typ. (A)	Saturation Current Max. (A)	Temperature Rise Current Typ. (A)	DC Resistance Max. (mΩ)
MDTE1580-2R0M	2.0	±20%	57.0	52.0	40.0	2.21
MDTE1580-2R2M	2.2	±20%	55.0	49.0	37.0	2.48
MDTE1580-3R0M	3.0	±20%	46.0	41.0	34.5	3.00
MDTE1580-4R2M	4.2	±20%	38.0	33.0	27.0	4.68
MDTE1580-5R3M	5.3	±20%	35.0	31.0	26.0	5.34
MDTE1580-6R2M	6.2	±20%	34.0	31.0	23.0	6.50
MDTE1580-7R2M	7.2	±20%	32.0	29.0	21.0	7.20
MDTE1580-8R2M	8.2	±20%	28.0	25.0	19.0	7.92
MDTE1580-100M	10	±20%	24.0	21.0	16.0	9.60
MDTE1580-150M	15	±20%	21.0	18.0	13.0	15.0
MDTE1580-220M	22	±20%	19.0	16.0	12.0	23.2

Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is \triangle T=40°C



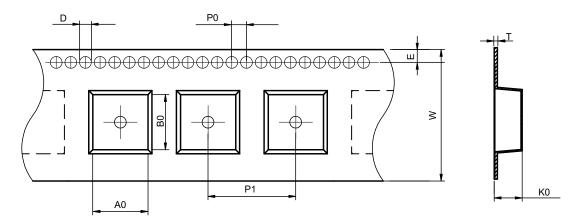
Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec. Allowed time above 217 °C : 60~90 sec. Max temperature: 260 °C. Max time at max temperature: 10 sec. Allowed Reflow time: 2x max.

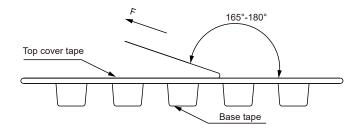
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE1580	17.0±0.1	16.0±0.1	1.5 ± 0.1	4.0±0.1	24.0±0.1	32.0±0.3	8.5±0.1	1.75±0.1	0.5±0.05

Peel force of top cover tape:



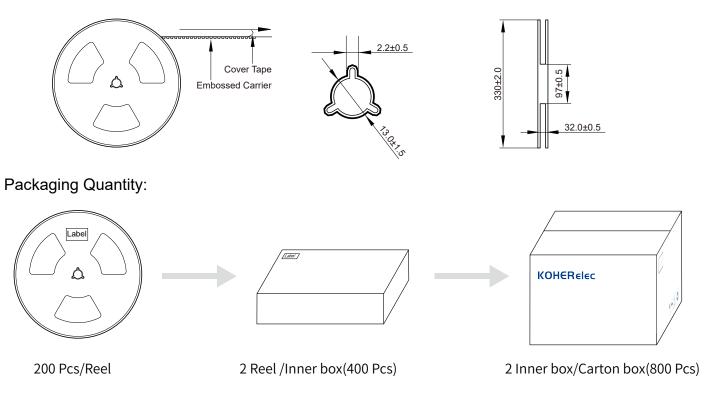
The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:



KOHERelec

Reel Dimension: [mm]



Cautions and Warnings:

Storage Conditions:

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Generally, Koher might not be familiar with either customer's specific application or actual requests as customer does. As a result customer shall be responsible for checking and confirming whether Koher product with the performance described in the product specification is suitable for using in customer's particular application or not.